

JEDEC  
SOLID STATE  
PRODUCT OUTLINE

THIS **REGISTERED OUTLINE** HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY; CHANGES ARE LIKELY TO OCCUR.

TITLE  
PLASTIC FLANGE MOUNTED  
POWER PACKAGE, 2 LEADS

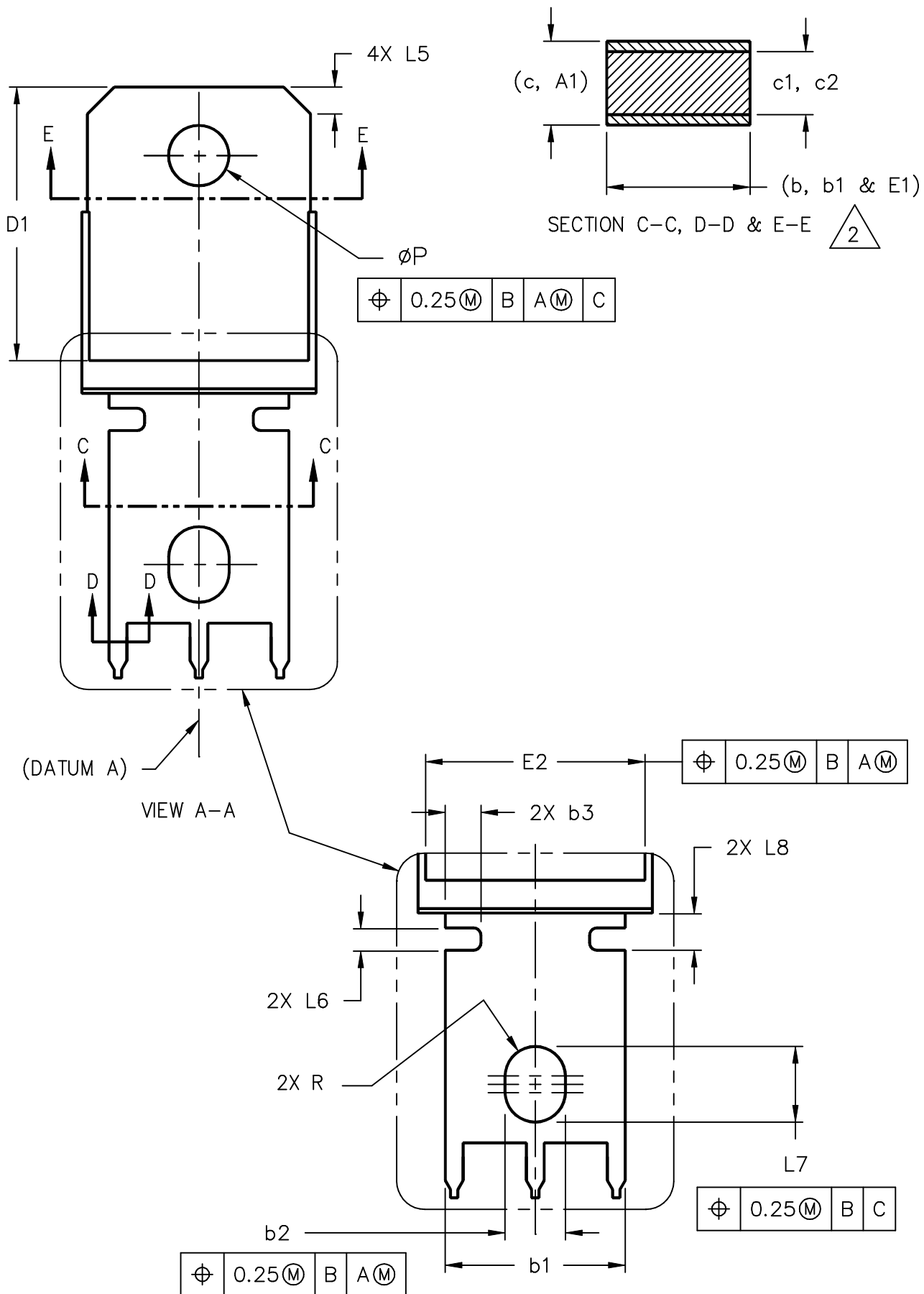
PACKAGE DESIGNATOR  
R-PSIP-F2

ISSUE  
A

DATE  
11/00

TO-275

SHEET  
1 OF 4





NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.



DIMENSIONS b, b1, c1 AND c2 APPLY TO BASE METAL ONLY.



DIMENSION D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 MILLIMETERS PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

4. ALL DIMENSIONS SHOWN IN MILLIMETERS.



LEAD TIP CONTOUR IS OPTIONAL AND SHALL EXTEND 1.50 MILLIMETERS MAXIMUM FROM LEAD TIP.

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